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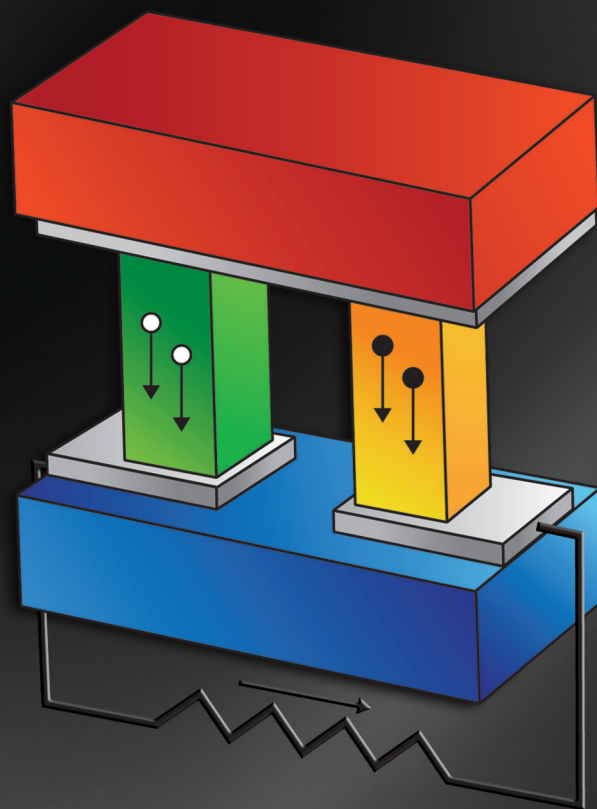
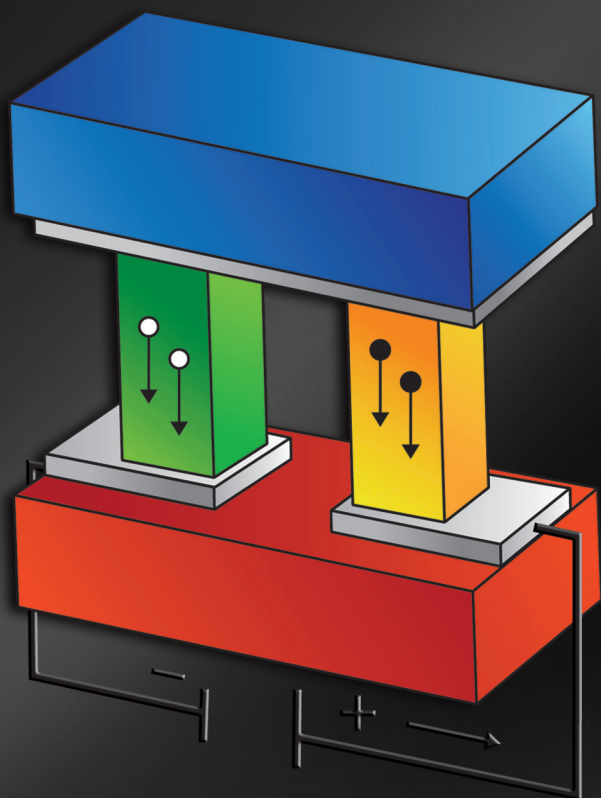


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Advances in Thermoelectric Materials II



Journal of MATERIALS RESEARCH

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